

## PATENT ABSTRACTS OF JAPAN

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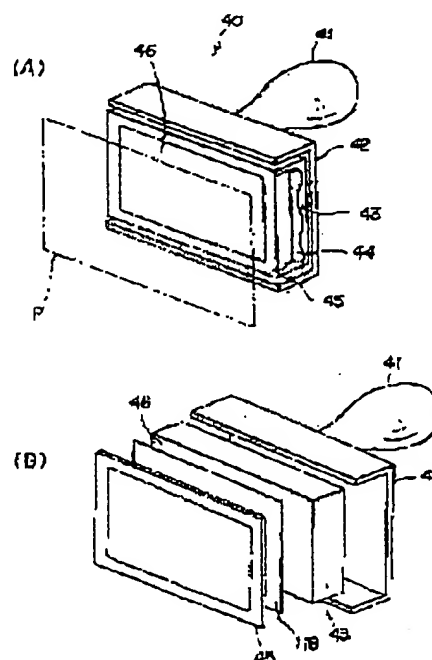
(72)Inventor : FUWA TETSUJI

## (54) STAMP DEVICE

(57)Abstract:

PURPOSE: To obtain a simple stamp device using heat-sensitive stencil base paper.

CONSTITUTION: On one surface of a frame body 43 incorporating an ink pad, heat-sensitive stencil base paper 118 with a perforated image is detachably mounted. The other surface of the frame body 43 is inserted into an outer frame 42 having a U-shaped cross section. A grip 41 is fixed on the back surface of the outer frame 42 in the center thereof.



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